

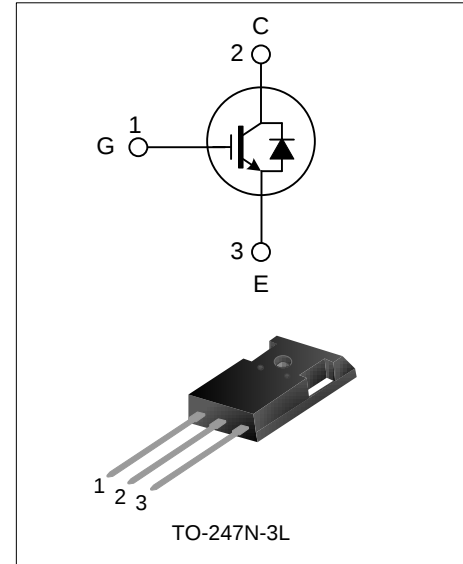
30A, 600V FIELD STOP IGBT

DESCRIPTION

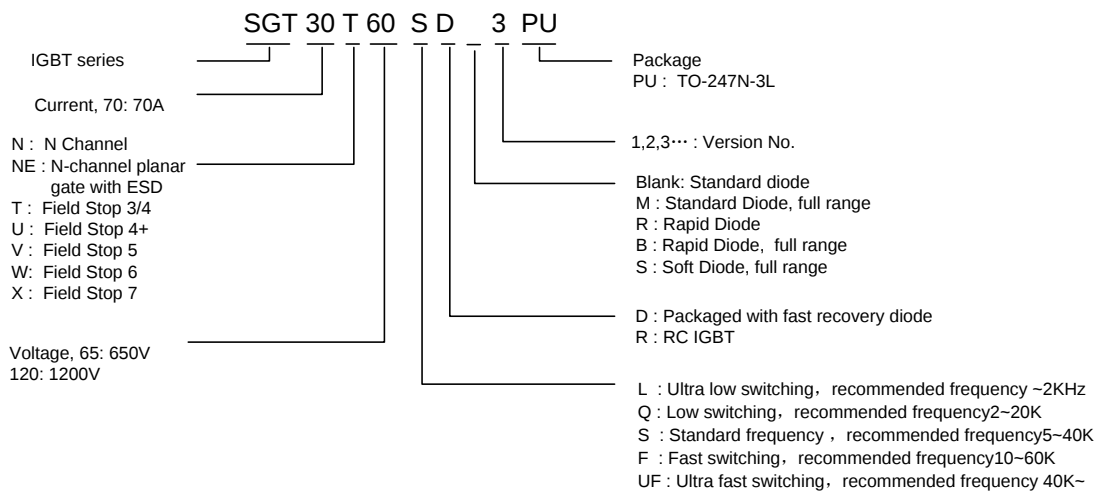
SGT30T60SD3PU adopts Field Stop III IGBT technology, offer the optimum performance for induction Heating, UPS, SMPS and PFC application.

FEATURES

- 30A, 600V, $V_{CE(sat)}(typ.)=1.65V@I_C=30A$
- Low conduction loss
- Fast switching
- High input impedance



NOMENCLATURE



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SGT30T60SD3PU	TO-247N-3L	30T60SD3	Halogen free	Tube

ABSOLUTE MAXIMUM RATINGS($T_C=25^{\circ}\text{C}$ UNLESS OTHERWISE NOTED)

Characteristics		Symbol	Ratings	Units
Collector to Emitter Voltage		V_{CE}	600	V
Gate to Emitter Voltage		V_{GE}	± 20	V
Collector Current	$T_C=25^{\circ}\text{C}$	I_C	60	A
	$T_C=100^{\circ}\text{C}$		30	
Pulsed Collector Current		I_{CM}	120	A
Diode Current		I_F	12	A
Maximum Power Dissipation ($T_C=25^{\circ}\text{C}$)		P_D	230	W
Operating Junction Temperature		T_J	$-55\sim+150$	$^{\circ}\text{C}$
Storage Temperature Range		T_{stg}	$-55\sim+150$	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Units
Thermal Resistance, Junction to Case (IGBT)	$R_{\theta JC}$	0.54	$^{\circ}\text{C/W}$
Thermal Resistance, Junction to Case (FRD)	$R_{\theta JC}$	1.5	$^{\circ}\text{C/W}$

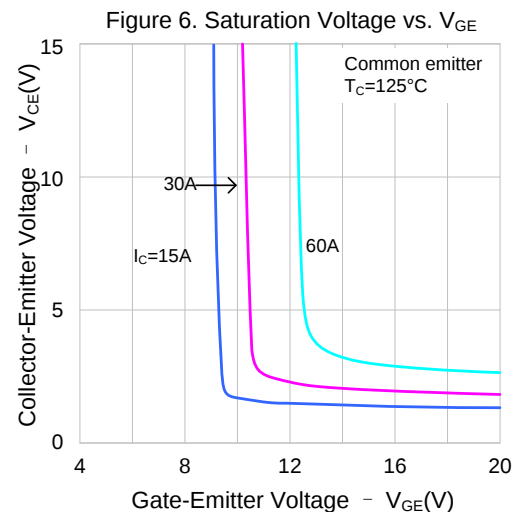
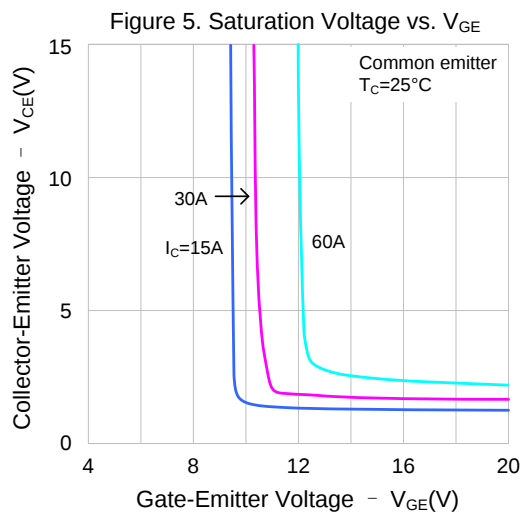
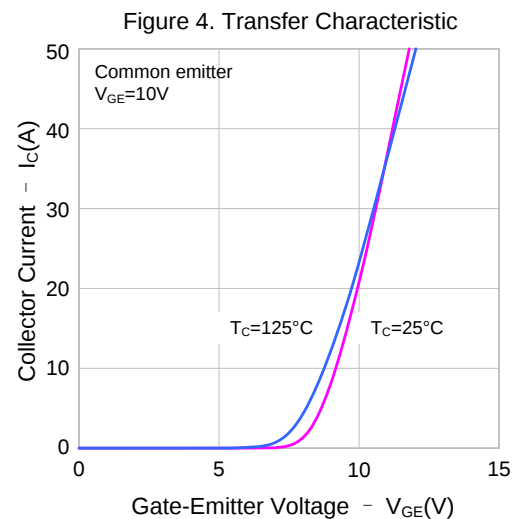
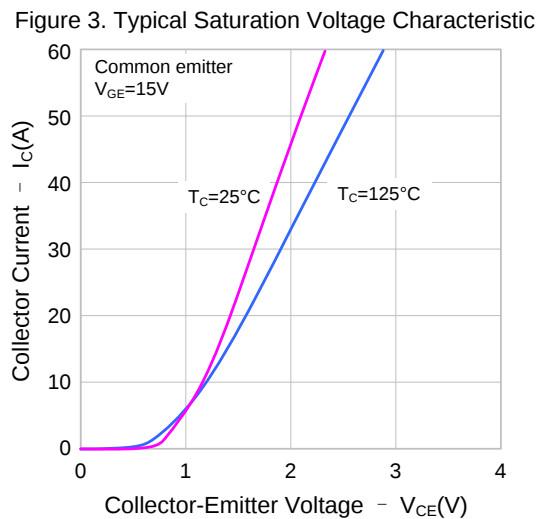
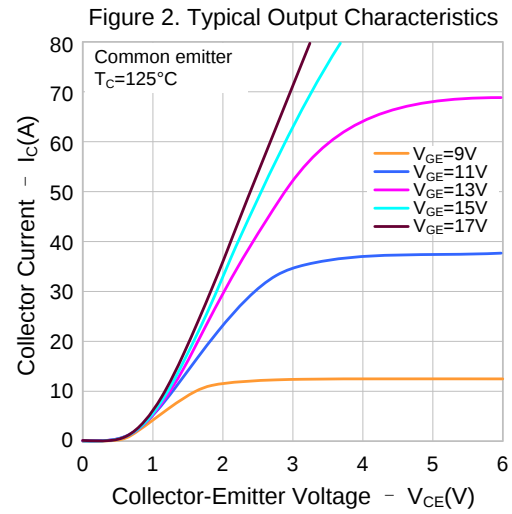
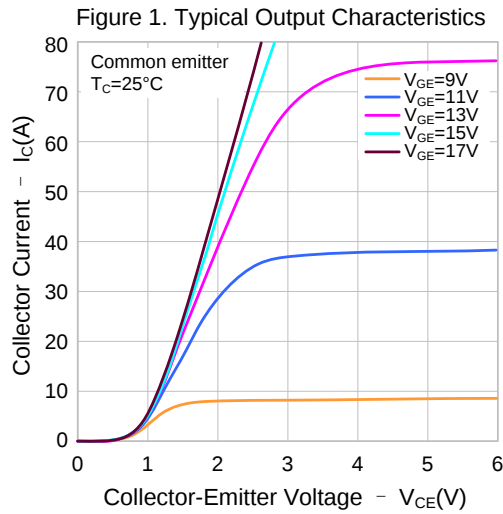
ELECTRICAL CHARACTERISTICS OF IGBT(T_C=25°C, UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Units
Collector to Emitter Breakdown Voltage	BV _{CE}	V _{GE} =0V, I _C =250uA	600	--	--	V
C-E Leakage Current	I _{CES}	V _{CE} =600V, V _{GE} =0V	--	--	200	μA
G-E Leakage Current	I _{GES}	V _{GE} =20V, V _{CE} =0V	--	--	±400	nA
G-E Threshold Voltage	V _{GE(th)}	I _C =250uA, V _{CE} =V _{GE}	4.0	5.0	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C =30A, V _{GE} =15V, T _C =25°C	--	1.65	2	V
		I _C =30A, V _{GE} =15V, T _C =125°C	--	1.9	--	V
Input Capacitance	C _{ies}	V _{CE} =30V	--	1780	--	pF
Output Capacitance	C _{oes}	V _{GE} =0V	--	100	--	
Reverse Transfer Capacitance	C _{res}	f=1MHz	--	32	--	
Turn-On Delay Time	T _{d(on)}	V _{CE} =400V I _C =30A R _g =10Ω V _{GE} =15V Inductive load	--	30	--	ns
Rise Time	T _r		--	105	--	
Turn-Off Delay Time	T _{d(off)}		--	67	--	
Fall Time	T _f		--	100	--	
Turn-On Switching Loss	E _{on}	Inductive load	--	1.85	--	mJ
Turn-Off Switching Loss	E _{off}		--	0.45	--	
Total Switching Loss	E _{st}		--	2.3	--	
Total Gate Charge	Q _g	V _{CE} =400V, I _C =30A, V _{GE} =15V	--	76	--	nC
Gate to Emitter Charge	Q _{ge}		--	20	--	
Gate to Collector Charge	Q _{gc}		--	38	--	

ELECTRICAL CHARACTERISTICS OF FRD (T_C=25°C UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Units
Diode Forward Voltage	V _{FM}	I _F =12A, T _C =25°C	--	1.8	--	V
		I _F =12A, T _C =125°C	--	1.4	--	
Diode Reverse Recovery Time	T _{rr}	I _{EC} =12A, dI _{EC} /dt=200A/μs	--	28	--	ns
Diode Reverse Recovery Charge	Q _{rr}	I _{EC} =12A, dI _{EC} /dt=200A/μs	--	55	--	nC

TYPICAL CHARACTERISTICS CURVE



TYPICAL CHARACTERISTICS CURVE (CONTINUED)

Figure 7. Saturation Voltage Drop vs. Temperature

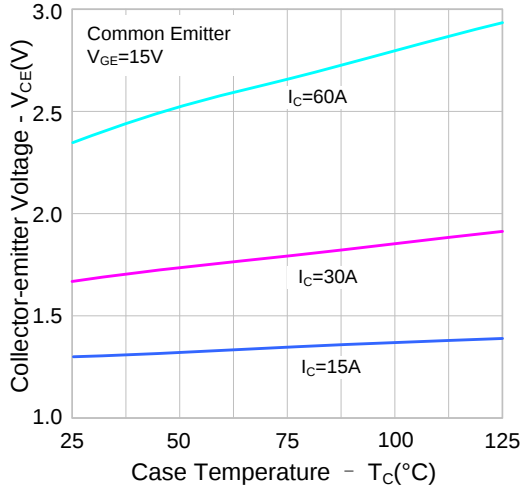


Figure 8. Capacitance Characteristic

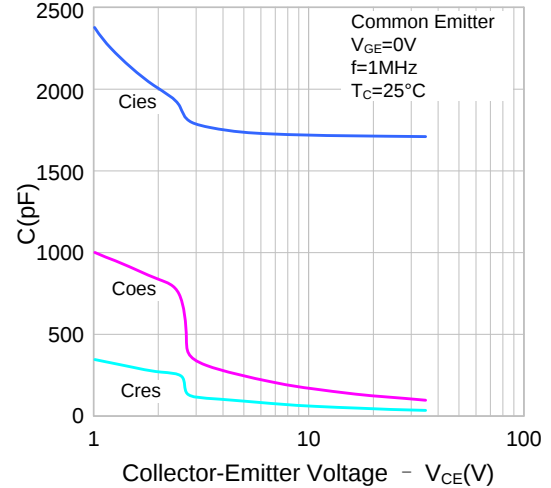


Figure 9. Gate Charge Characteristic

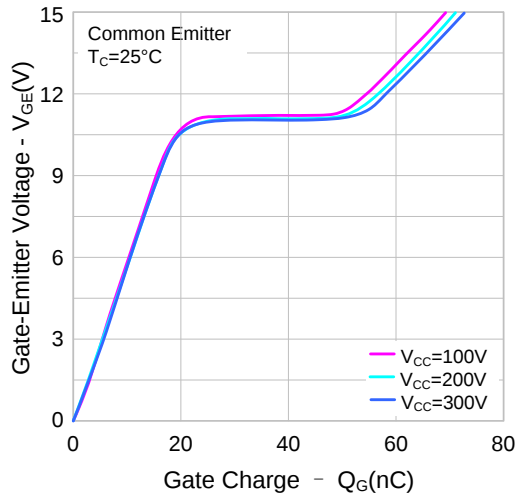


Figure 10. Turn-on Characteristic vs. Gate Resistance

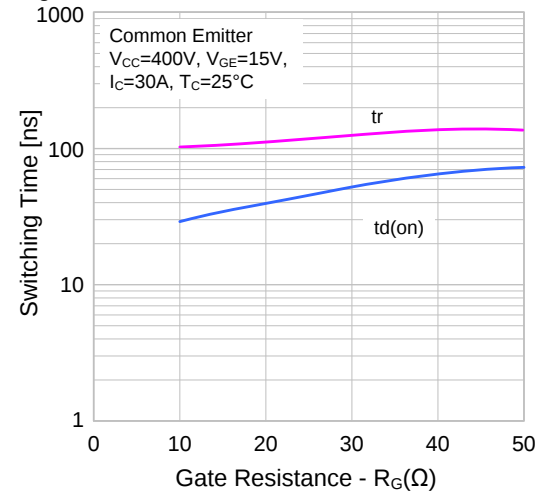


Figure 11. Turn-off Characteristic vs. Gate Resistance

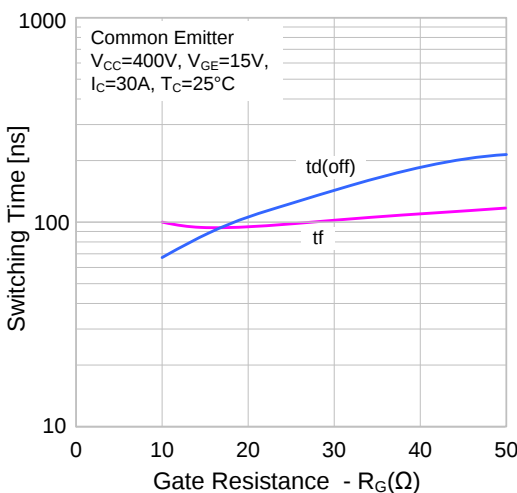
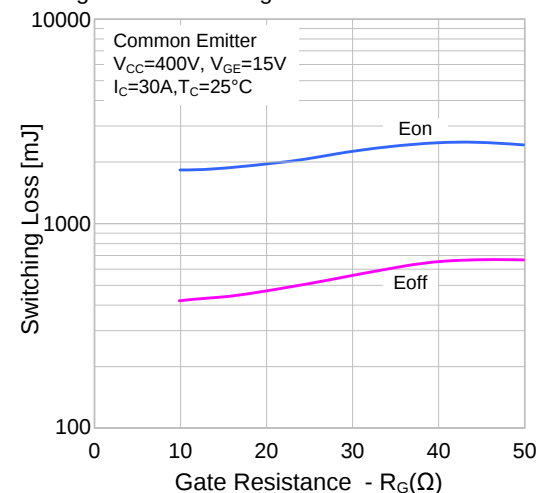


Figure 12. Switching Loss vs. Gate Resistance



TYPICAL CHARACTERISTICS CURVE (CONTINUED)

Figure 13. Turn-on Characteristic vs. Collector Current

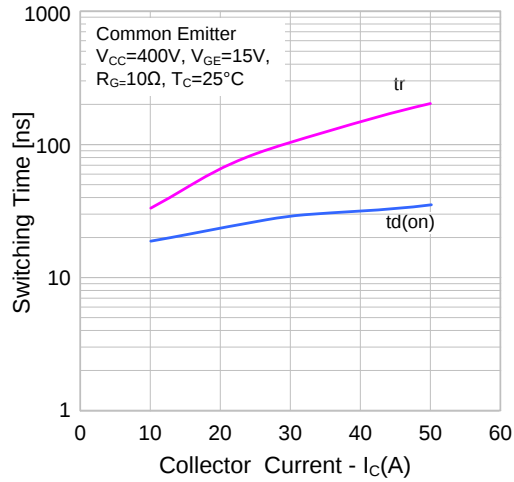


Figure 14. Turn-off Characteristic vs. Collector Current

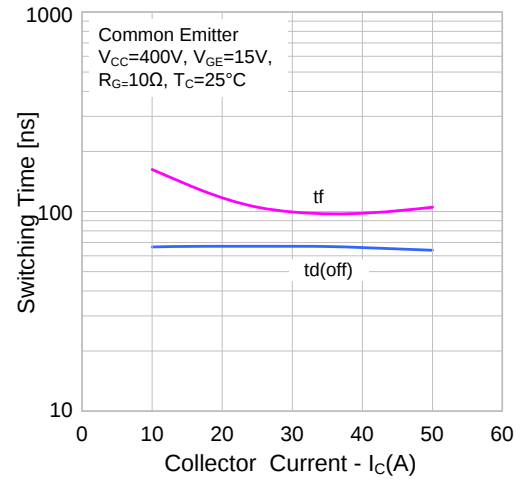


Figure 15. Switching Loss vs. Collector Current

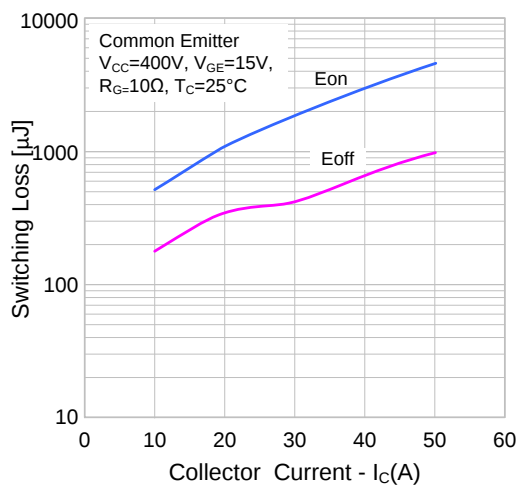


Figure 16. Forward Characteristic

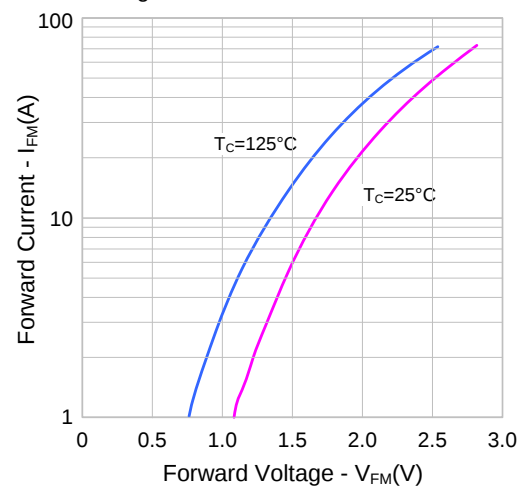


Figure 17. Reverse Recovery Time vs. Forward Current

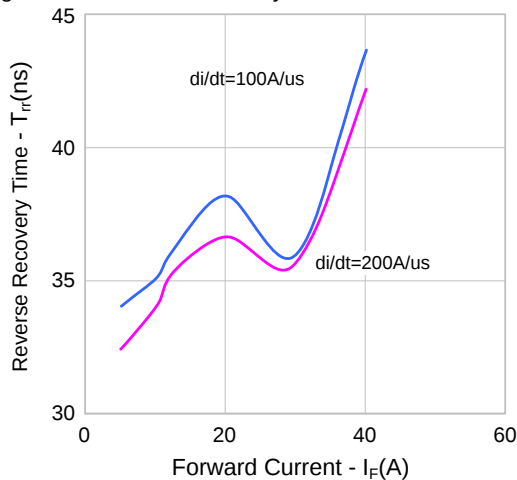
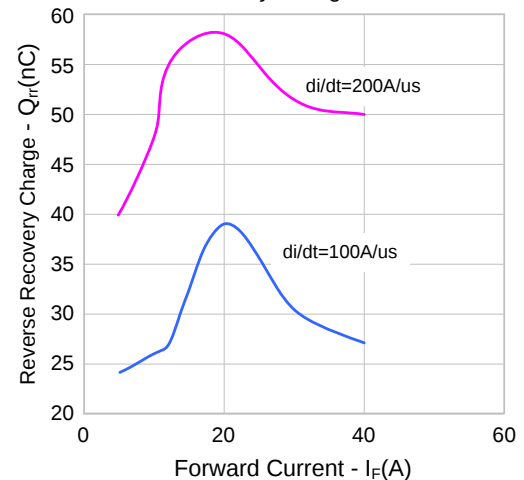
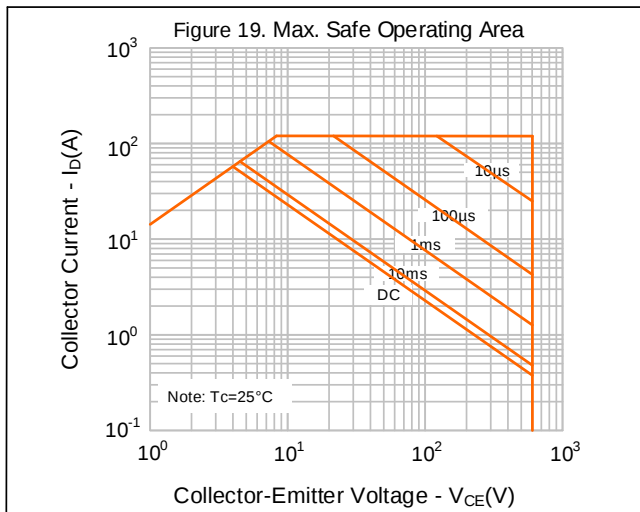


Figure 18. Reverse Recovery Charge vs. Forward Current



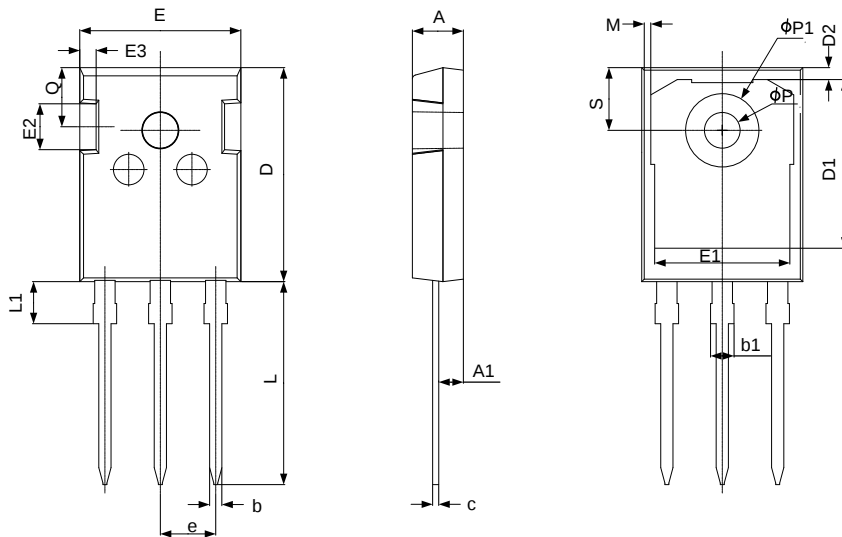
TYPICAL CHARACTERISTICS CURVE (CONTINUED)



PACKAGE OUTLINE

TO-247N-3L

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
b	1.16	—	1.26
b1	—	—	2.25
c	0.59	—	0.66
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	1.50	1.60	1.70
e	5.436 BSC		
L	19.80	19.92	20.10
L1	—	—	4.30
M	0.35	—	0.95
P	3.40	3.50	3.60
P1	7.00	—	7.40
Q	5.60	—	6.00
S	6.05	6.15	6.25

Important notice :

1. The instructions are subject to change without notice!
2. Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current. Please read the instructions carefully before using our products, including the circuit operation precautions.
3. Our products are consumer electronic products or the other civil electronic products.
4. When using our products, please do not exceed the maximum rating of the products, otherwise the reliability of the whole machine will be affected. There is a certain possibility of failure or malfunction of any semiconductor product under specific conditions. The buyer is responsible for complying with safety standards and taking safety measures when using our products for system design, sample and whole machine manufacturing, so as to avoid potential failure risk that may cause personal injury or property loss.
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Rev.: 1.3

Revision History:

1. Update SOA

Rev.: 1.2

Revision History:

1. Update Ratings of Pulsed Collector Current

Rev.: 1.1

Revision History:

1. Update the package outline

Rev.: 1.0

Revision History:

1. Preliminary
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